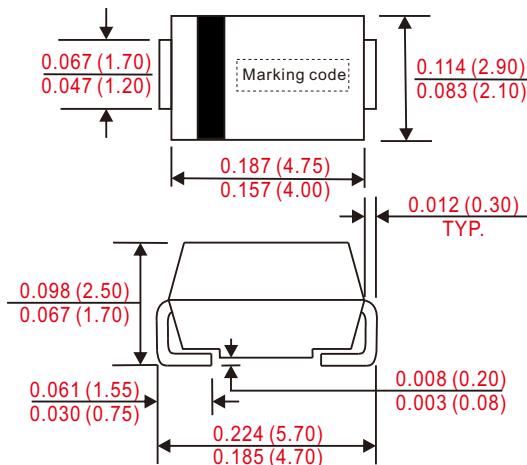


■ Features

- Low profile surface mounted application in order to optimize board space.
- High current capability.
- High surge capability.
- Glass passivated chip junction inside.
- Suffix "G" indicates Halogen-free part, ex.GS1AG.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

■ Outline

SMA(DO-214AC)



Dimensions in inches and (millimeters)

■ Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case : Molded plastic, DO-214AC / SMA
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : Indicated by cathode band
- Weight : 0.002 ounce, 0.055 gram

■ Maximum ratings and electrical characteristics

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

| Parameter | Conditions | | Symbol | MIN. | TYP. | MAX. | UNIT |
|----------------------------|--|--|-----------------|------|------|------|------|
| Forward rectified current | at $T_L = 110^\circ\text{C}$ | | I_O | | | 1.0 | A |
| Forward surge current | 8.3ms single half sine-wave superimposed on rate load (JEDEC method) | | I_{FSM} | | | 30 | A |
| Reverse current | $V_R = V_{RRM} T_A = 25^\circ\text{C}$ | | I_R | | | 5.0 | uA |
| | $V_R = V_{RRM} T_A = 125^\circ\text{C}$ | | | | | 100 | |
| Thermal resistance | Junction to ambient | | $R_{\theta JA}$ | | 75 | | °C/W |
| Diode junction capacitance | f=1MHz and applied 4V DC reverse voltage | | C_J | | 15 | | pF |
| Storage temperature | | | T_{STG} | -55 | | +150 | °C |

| Symbol | Marking code | Max. repetitive peak reverse voltage V_{RRM} (V) | Max. RMS voltage V_{RMS} (V) | Max. DC blocking voltage V_R (V) | Max. forward voltage @1.0A, $T_A = 25^\circ\text{C}$ V_F (V) | Operating Junction temperature T_J (°C) |
|--------|--------------|--|--------------------------------|------------------------------------|--|---|
| GS1A | GS1A | 50 | 35 | 50 | 1.10 | -55 ~ +150 |
| GS1B | GS1B | 100 | 70 | 100 | | |
| GS1D | GS1D | 200 | 140 | 200 | | |
| GS1G | GS1G | 400 | 280 | 400 | | |
| GS1J | GS1J | 600 | 420 | 600 | | |
| GS1K | GS1K | 800 | 560 | 800 | | |
| GS1M | GS1M | 1000 | 700 | 1000 | | |

■ Rating and characteristic curves

Fig. 1 - Forward Current Derating Curve

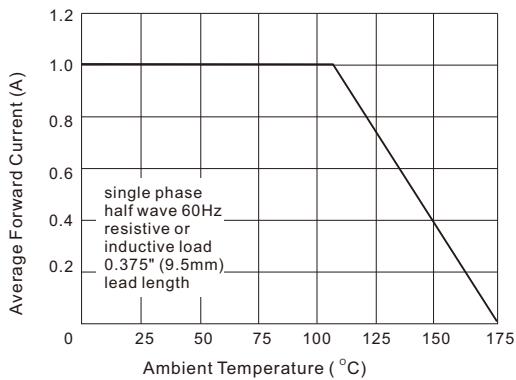


Fig. 3 - Typical Instantaneous Forward Characteristics

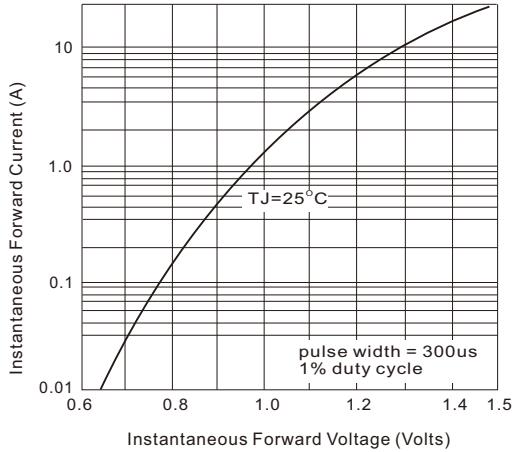


Fig. 5 - Typical Junction Capacitance

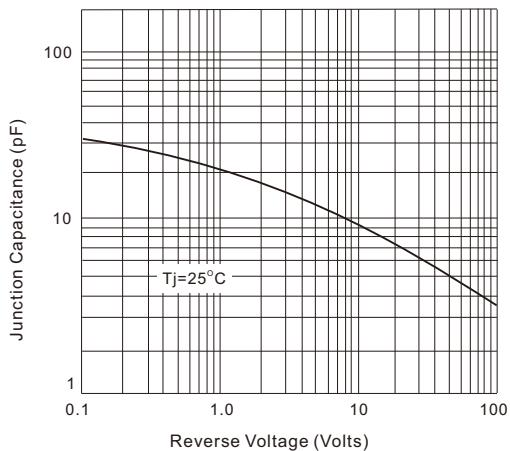


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

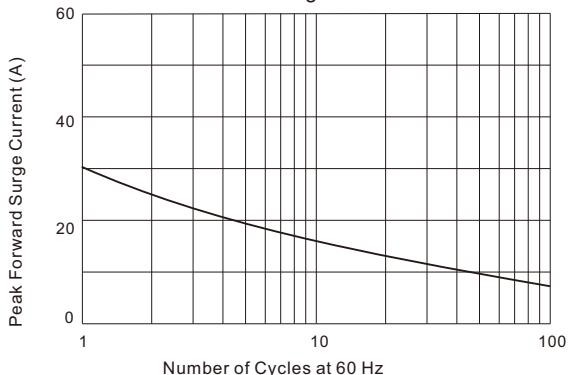
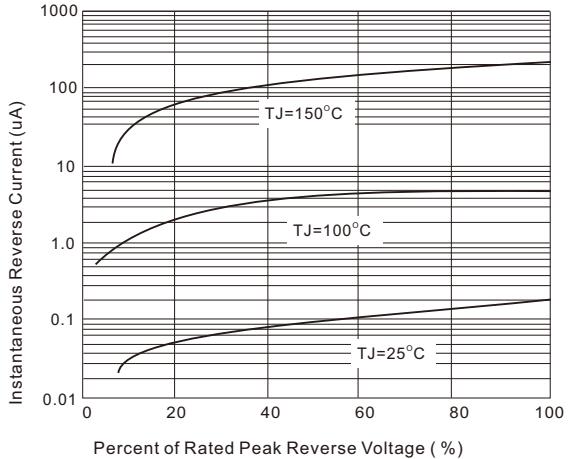
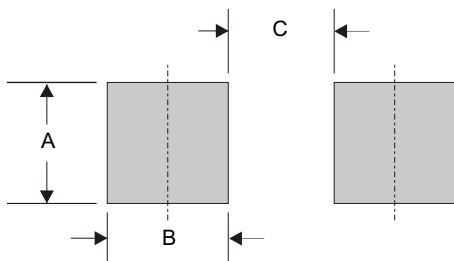


Fig. 4 - Typical Reverse Characteristics



■ SMA foot print

| A | B | C |
|--------------|--------------|--------------|
| 0.068 (1.70) | 0.104 (2.60) | 0.060 (1.50) |

Dimensions in inches and (millimeters)

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